

October 1997

Fast CMOS 16-Bit Octal Buffer/Line Drivers
Features

- **Advanced 0.6 micron CMOS Technology**
- **These Devices Are High-speed, Low Power Devices with High Current Drive**
- **$V_{CC} = 5V \pm 10\%$**
- **Hysteresis on All Inputs**
- **Output Skew: $\leq 0.5ns$**
- **CD74FCT16541T**
 - **High Output Drive: $I_{OH} = -32mA$; $I_{OL} = 64mA$**
 - **Power Off Disable Outputs Permit "Live Insertion"**
 - **Typical V_{OLP} (Output Ground Bounce) $< 1.0V$ at $V_{CC} = 5V$, $T_A = 25^\circ C$**
- **CD74FCT162541T**
 - **Balanced Output Drivers: $\pm 24mA$**
 - **Reduced System Switching Noise**
 - **Typical V_{OLP} (Output Ground Bounce) $< 0.6V$ at $V_{CC} = 5V$, $T_A = 25^\circ C$**
- **CD74FCT162H541T**
 - **Bus Hold Retains Last Active Bus State During Three-State**
 - **Eliminates the Need for External Pull-up Resistors**

Description

These devices are non-inverting 16-bit buffer/line drivers designed for applications driving high capacitance loads and low impedance backplanes. These high-speed, low power devices offer bus/backplane interface capability and a flow-through organization for ease of board layout. These devices are designed with three-state controls to operate in a Dual-Byte, or a single 16-bit word mode.

The CD74FCT16541T output buffers are designed with a Power-Off disable allowing "live insertion" of boards when used as backplane drivers.

The CD74FCT162541T has $\pm 24mA$ balanced output drivers. It is designed with current limiting resistors at its outputs to control the output edge rate resulting in lower ground bounce and undershoot. This eliminates the need for external terminating resistors for most interface applications.

The CD74FCT162H541T has "Bus Hold" which retains the input's last state whenever the input goes to high-impedance preventing "floating" inputs and eliminating the need for pull-up/down resistors.

Ordering Information

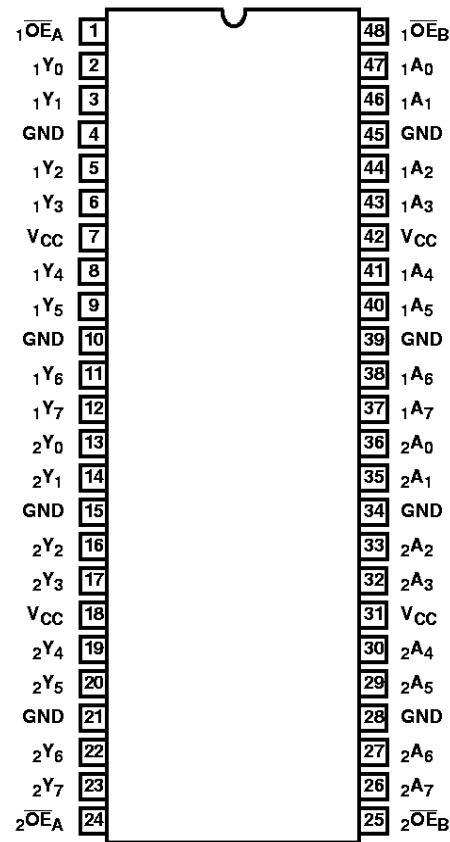
PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CD74FCT16541ATMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT16541ATSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT16541CTMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT16541CTSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT16541DTMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT16541DTSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT16541ETMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT16541ETSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT16541TMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT16541TSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162541ATMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162541ATSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162541CTMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162541CTSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162541DTMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162541DTSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162541ETMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162541ETSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162541TMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162541TSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162H541ATMT	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162H541ATSM	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162H541CTMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162H541CTSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162H541DTMT	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162H541DTSM	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162H541ETMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162H541ETSM	-40 to 85	48 Ld SSOP	M48.300-P
CD74FCT162H541TMT	-40 to 85	48 Ld TSSOP	M48.240-P
CD74FCT162H541TSM	-40 to 85	48 Ld SSOP	M48.300-P

NOTE: When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.

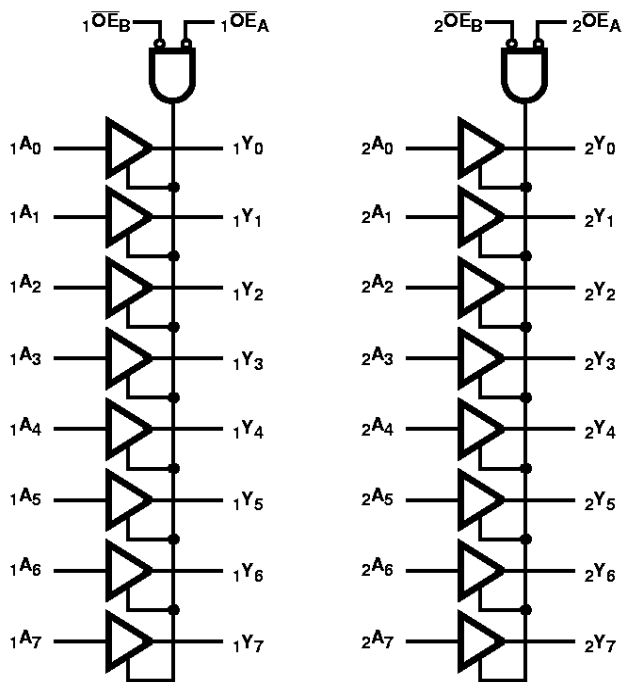
CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T

Pinout

CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T
(SSOP, TSSOP)
TOP VIEW



Functional Block Diagram



TRUTH TABLE (NOTE 1)

INPUTS		OUTPUTS
$x\overline{OE}$	$x A_x$	$x Y_x$
L	L	H
L	H	L
H	X	Z

NOTE:

- 1. H = High Voltage Level
L = Low Voltage Level
X = Don't Care
Z = High Impedance

Pin Descriptions

PIN NAME	DESCRIPTION
$x\overline{OE}$	Three-State Output Enable Inputs (Active LOW)
$x A_x$	Inputs (Note 2)
$x Y_x$	Three-State Outputs
GND	Ground
V _{CC}	Power

NOTE:

- 2. For the CD74FCT162H541T, these pins have "Bus Hold". All other pins are standard, outputs, or I/Os.

CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T

Absolute Maximum Ratings

DC Input Voltage -0.5V to 7.0V
DC Output Current 120mA

Operating Conditions

Operating Temperature Range -40°C to 85°C
Supply Voltage to Ground Potential
Inputs and V_{CC} Only -0.5V to 7.0V
Supply Voltage to Ground Potential
Outputs and D/O Only -0.5V to 7.0V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

3. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Thermal Information

Thermal Resistance (Typical, Note 3) θ_{JA} (°C/W)
TSSOP Package 94
SSOP Package 76
Maximum Junction Temperature 150°C
Maximum Storage Temperature Range -65°C to 150°C
Maximum Lead Temperature (Soldering 10s) 300°C
(Lead Tips Only)

Electrical Specifications

PARAMETER	SYMBOL	(NOTE 4) TEST CONDITIONS	MIN	(NOTE 5) TYP	MAX	UNITS
DC ELECTRICAL SPECIFICATIONS Over the Operating Range, T _A = -40°C to 85°C, V _{CC} = 5.0V ±10%						
Input HIGH Voltage	V _{IH}	Guaranteed Logic HIGH Level	2.0	-	-	V
Input LOW Voltage	V _{IL}	Guaranteed Logic LOW Level	-	-	0.8	V
Input HIGH Current	I _{IH}	Standard Input, V _{CC} = Max V _{IN} = V _{CC}	-	-	1	μA
Input HIGH Current	I _{IH}	Standard I/O, V _{CC} = Max V _{IN} = V _{CC}	-	-	1	μA
Input HIGH Current	I _{IH}	Bus Hold Input (Note 7) V _{CC} = Max V _{IN} = V _{CC}	-	-	±100	μA
Input HIGH Current	I _{IH}	Bus Hold I/O (Note 7) V _{CC} = Max V _{IN} = V _{CC}	-	-	±100	μA
Input LOW Current	I _{IL}	Standard Input, V _{CC} = Min V _{IN} = GND	-	-	-1	μA
Input LOW Current	I _{IL}	Standard I/O, V _{CC} = Min V _{IN} = GND	-	-	-1	μA
Input LOW Current	I _{IL}	Bus Hold Input (Note 7) V _{CC} = Min V _{IN} = GND	-	-	±100	μA
Input LOW Current	I _{IL}	Bus Hold I/O (Note 7) V _{CC} = Min V _{IN} = GND	-	-	±100	μA
Bus Hold Sustain Current	I _{BHH}	Bus Hold Input (Note 7) V _{CC} = Min	V _{IN} = 2.0V	-	-	μA
	I _{BHL}		V _{IN} = 0.8V	-	-	μA
High Impedance Output Current (Three-State) (Note 8)	I _{OZH}	V _{CC} = Max V _{OUT} = 2.7V	-	-	1	μA
	I _{OZL}	V _{CC} = Max V _{OUT} = 0.5V	-	-	-1	μA
Clamp Diode Voltage	V _{IK}	V _{CC} = Min, I _{IN} = -18mA	-	-0.7	-1.2	V
Short Circuit Current	I _{OS}	V _{CC} = Max (Note 6), V _{OUT} = GND	-80	-140	-200	mA
Output Drive Current	I _O	V _{CC} = Max (Note 6), V _{OUT} = 2.5V	-50	-	-180	mA
Input Hysteresis	V _H		-	100	-	mV

CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T

Electrical Specifications (Continued)

PARAMETER	SYMBOL	(NOTE 4) TEST CONDITIONS	MIN	(NOTE 5) TYP	MAX	UNITS
CD74FCT16541T OUTPUT DRIVE SPECIFICATIONS Over the Operating Range						
Output HIGH Voltage	V_{OH}	$V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -3.0\text{mA}$	2.5	3.5	V
			$I_{OH} = -15.0\text{mA}$	2.4	3.5	V
			$I_{OH} = -32.0\text{mA}$	2.0	3.0	V
Output LOW Voltage	V_{OL}	$V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 64\text{mA}$	-	0.2	0.55 V
Power Down Disable	I_{OFF}	$V_{CC} = 0\text{V}, V_{IN} \text{ or } V_{OUT} \leq 4.5\text{V}$	-	-	± 100	μA
CD74FCT162541T, CD74FCT162H541T OUTPUT DRIVE SPECIFICATIONS Over the Operating Range						
Output HIGH Voltage	V_{OH}	$V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -24.0\text{mA}$	2.4	3.3	V
Output LOW Voltage	V_{OL}	$V_{CC} = \text{Min}, V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 24\text{mA}$	-	0.3	0.55 V
Output LOW Current	I_{ODL}	$V_{CC} = 5\text{V}, V_{IN} = V_{IH} \text{ or } V_{IL}, V_{OUT} = 1.5\text{V}$ (Note 6)	60	115	150	mA
Output HIGH Current	I_{ODH}	$V_{CC} = 5\text{V}, V_{IN} = V_{IH} \text{ or } V_{IL}, V_{OUT} = 1.5\text{V}$ (Note 6)	-60	-115	-150	mA
CAPACITANCE $T_A = 25^\circ\text{C}, f = 1\text{MHz}$						
Input Capacitance (Note 9)	C_{IN}	$V_{IN} = 0\text{V}$	-	4.5	6	pF
Output Capacitance (Note 9)	C_{OUT}	$V_{OUT} = 0\text{V}$	-	5.5	8	pF
POWER SUPPLY SPECIFICATIONS						
Quiescent Power Supply Current	I_{CC}	$V_{CC} = \text{Max}$	$V_{IN} = \text{GND or } V_{CC}$	-	0.1	500 μA
Supply Current per Input at TTL HIGH	ΔI_{CC}	$V_{CC} = \text{Max}$	$V_{IN} = 3.4\text{V}$ (Note 10)	-	0.5	1.5 mA
Supply Current per Input per MHz (Note 11)	I_{CCD}	$V_{CC} = \text{Max}, \text{Outputs Open}$ $\overline{XOE} = \text{GND}$ One Bit Toggling 50% Duty Cycle	$V_{IN} = V_{CC}$ $V_{IN} = \text{GND}$	-	60	100 $\mu\text{A}/\text{MHz}$
Total Power Supply Current (Note 13)	I_C	$V_{CC} = \text{Max}, \text{Outputs Open}$ $f_I = 10\text{MHz}, 50\% \text{ Duty Cycle}$ $\overline{XOE} = \text{GND}$ One Bit Toggling	$V_{IN} = V_{CC}$ $V_{IN} = \text{GND}$	-	0.6	1.5 (Note 12) mA
			$V_{IN} = 3.4\text{V}$ $V_{IN} = \text{GND}$	-	0.9	2.3 (Note 12) mA
		$V_{CC} = \text{Max}, \text{Outputs Open}$ $f_I = 2.5\text{MHz}$ 50% Duty Cycle $\overline{XOE} = \text{GND}$ 16 Bits Toggling	$V_{IN} = V_{CC}$ $V_{IN} = \text{GND}$	-	2.4	4.5 (Note 12) mA
			$V_{IN} = 3.4\text{V}$ $V_{IN} = \text{GND}$	-	6.4	16.5 (Note 12) mA

CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T

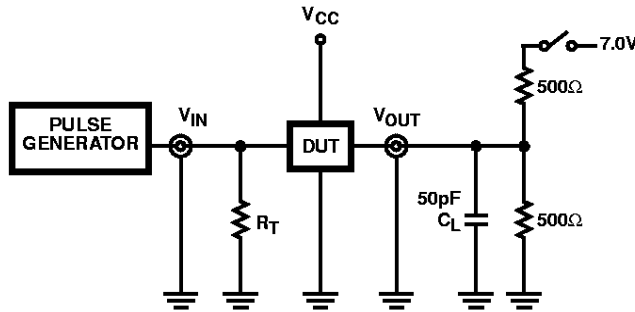
Switching Specifications Over Operating Range

PARAMETER	SYMBOL	(NOTE 14) TEST CONDITIONS	T		AT		CT		DT		ET		UNITS
			(NOTE 15) MIN	MAX	(NOTE 15) MIN	MAX	(NOTE 15) MIN	MAX	(NOTE 15) MIN	MAX	(NOTE 15) MIN	MAX	
CD74FCT16541T, CD74FCT162541T, CD74FCT162H541T													
Propagation Delay xAX to xYX	tPLH, tPHL	CL = 50pF RL = 500Ω	1.5	8.0	1.5	4.8	1.5	4.3	1.5	3.6	1.5	3.2	ns
Output Enable Time xOE to xAX or xYX	tPZH, tPZL		1.5	10.0	1.5	6.2	1.5	5.8	1.5	4.8	1.5	4.4	ns
Output Disable Time (Note 16) xOE to xAX or xYX	tPHZ, tPLZ	FCT16541T, FCT162541T	1.5	9.5	1.5	5.6	1.5	5.2	1.5	4.0	1.5	3.6	ns
		FCT162H541T	1.5	9.5	1.5	5.6	1.5	5.2	1.5	4.0	1.5	4.0	ns
Output Skew (Note 17)	tSK(O)		-	0.5	-	0.5	-	0.5	-	0.5	-	0.5	ns

NOTES:

- For conditions shown as Max or Min, use appropriate value specified under Electrical Specifications for the applicable device type.
- Typical values are at $V_{CC} = 5.0\text{V}$, 25°C ambient and maximum loading, except as noted.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Pins with Bus Hold are identified in the pin description.
- This specification does not apply to bi-directional functionalities with Bus Hold.
- This parameter is determined by device characterization but is not production tested.
- Per TTL driven input ($V_{IN} = 3.4\text{V}$); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- $I_C = I_{\text{QUIESCENT}} + I_{\text{INPUTS}} + I_{\text{DYNAMIC}}$
 $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_I N_I)$
 I_{CC} = Quiescent Current
 ΔI_{CC} = Power Supply Current for a TTL High Input ($V_{IN} = 3.4\text{V}$)
 D_H = Duty Cycle for TTL Inputs High
 N_T = Number of TTL Inputs at D_H
 I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
 f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 f_I = Input Frequency
 N_I = Number of Inputs at f_I
All currents are in milliamps and all frequencies are in megahertz.
- See test circuit and wave forms.
- Minimum limits are guaranteed but not tested on Propagation Delays.
- This parameter is guaranteed but not production tested.
- Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.

Test Circuits and Waveforms



SWITCH POSITION	
TEST	SWITCH
t_{PLZ} , t_{PZL}	Closed
t_{PHZ} , t_{PZH} , t_{PLH} , t_{PHL}	Open

DEFINITIONS:

C_L = Load capacitance, includes jig and probe capacitance.

R_T = Termination resistance, should be equal to Z_{OUT} of the Pulse Generator.

NOTE:

18. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $Z_{OUT} \leq 50\Omega$;
 t_f , $t_r \leq 2.5\text{ns}$.

FIGURE 1. TEST CIRCUIT

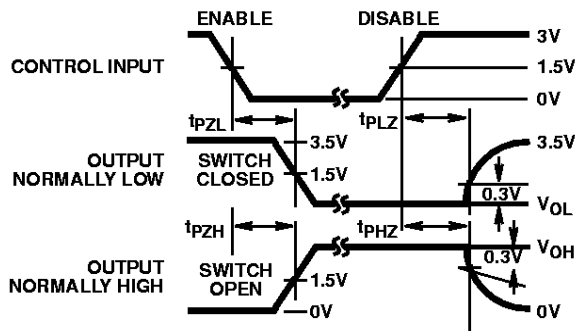


FIGURE 2. ENABLE AND DISABLE TIMING

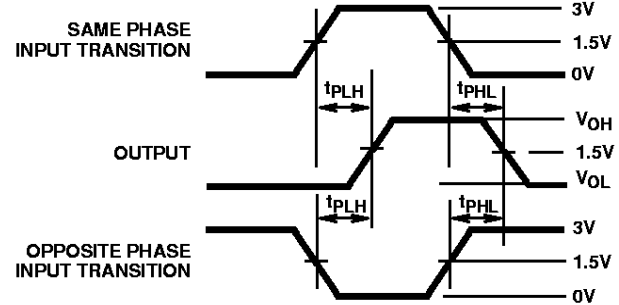


FIGURE 3. PROPAGATION DELAY

All Harris Semiconductor products are manufactured, assembled and tested under **ISO9000** quality systems certification.

Harris Semiconductor products are sold by description only. Harris Semiconductor reserves the right to make changes in circuit design and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Harris is believed to be accurate and reliable. However, no responsibility is assumed by Harris or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Harris or its subsidiaries.

Sales Office Headquarters

For general information regarding Harris Semiconductor and its products, call **1-800-4-HARRIS**

NORTH AMERICA

Harris Semiconductor
 P. O. Box 883, Mail Stop 53-210
 Melbourne, FL 32902
 TEL: 1-800-442-7747
 (407) 729-4984
 FAX: (407) 729-5321

EUROPE

Harris Semiconductor
 Mercure Center
 100, Rue de la Fusée
 1130 Brussels, Belgium
 TEL: (32) 2.724.2111
 FAX: (32) 2.724.22.05

ASIA

Harris Semiconductor PTE Ltd.
 No. 1 Tannery Road
 Cencon 1, #09-01
 Singapore 1334
 TEL: (65) 748-4200
 FAX: (65) 748-0400

